5-800 MHz Internally Matched IF Amplifier



Device Features

- OIP3 = 40.0 dBm @ 70 MHz
- Gain = 27.1 dB @ 70 MHz
- Output P1 dB = 21.3 dBm @ 70 MHz
- 50 Ω Cascadable
- Patented temperature compensation
- Patented over voltage protection
- Lead-free/RoHS-compliant SOT-89 SMT package



Product Description

BeRex's BIF7 is a high performance InGaP/GaAs HBT MMIC amplifier, internally matched to 50 Ohms and uses a patented *temperature compensation* circuit to provide stable current over the operating temperature range without the need for external components and a patented *over voltage protection* circuit to protect a internal device. The BIF7 is designed for high linearity IF amplifier that requires excellent gain, high OIP3 and flatness. It is packaged in a RoHS-compliant with SOT-89 surface mount package.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Typical Performance¹

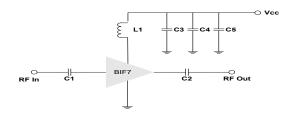
Parameter	Frequency Unit						
	70	140	250	500	800	MHz	
Gain	27.1	27.0	26.7	25.7	25.0	dB	
S11	-32.0	-41.0	-38.5	-28.6	-23.2	dB	
S22	-12.1	-11.6	-10.1	-7.2	-6.5	dB	
OIP3 ²	40.0	38.5	38.0	36.0	32.5	dBm	
P1dB	21.3	21.5	21.5	21.0	19.7	dBm	
Noise Figure	2.9	2.9	3.0	3.0	3.0	dB	

¹ Device performance $_$ measured on a BeRex evaluation board at 25°C, 50 Ω system.

² OIP3 _ measured with two tones at an output of 10 dBm per tone separated by 1 MHz.

	Min.	Typical	Max.	Unit
Bandwidth	5		800	MHz
I _C @ (Vc = 5V)	85	95	105	mA
V _C		5.0		V
dG/dT		-0.003		dB/°C
R _{TH}		50		°C/W

Applications Circuit



^{*}C1, C2=100nF ± 5%; C3 = 100 pF ± 5%; C4 = 1000pF ±5%

Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+6.0	V
Supply Current	160	mA
Input RF Power	23	dBm

Operation of this device above any of these parameters may result in permanent damage.

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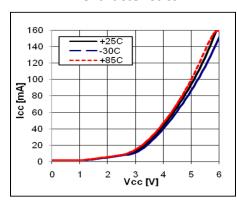
•website: www.berex.com

^{*}C5 = 10uF; L1 = 1uH ±5%

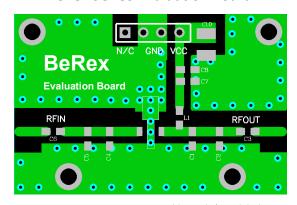
^{*}C1, C2 = 100pF; L1 = $12nH \pm 5\%$ for RF Bandwidth







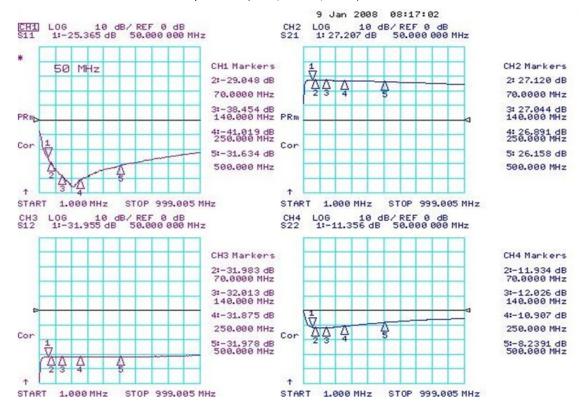
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

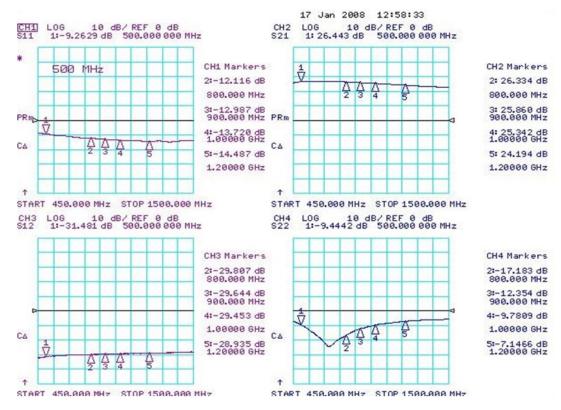
S-parameters (Vc=5V, Ic=95mA, T=25°C)





RF Bandwidth

S-parameters (Vc=5V, Ic=95mA, T=25°C)





S-Parameter

(Vdevice = 5.0V, Icc = 95mA, T = 25 °C, calibrated to device leads)

Freq [MHz]	S11 [Mag]	S11 [Ang]	S21 [Mag]	S21 [Ang]	S12 [Mag]	S12 [Ang]	S22 [Mag]	S22 [Ang]
100	0.590	175.3	25.200	170.9	0.027	2.7	0.242	-20.9
500	0.540	155.4	19.772	139.2	0.027	10.0	0.341	-92.7
1000	0.484	140.8	14.791	116.0	0.028	21.8	0.449	-148.9
1500	0.495	126.4	12.899	102.3	0.039	30.7	0.541	171.2
2000	0.443	114.8	10.915	76.4	0.044	26.5	0.568	139.2
2500	0.492	100.3	9.942	69.3	0.051	33.4	0.593	113.8
3000	0.473	82.1	10.121	41.0	0.062	22.0	0.609	89.9
3500	0.499	70.9	7.532	20.2	0.062	17.5	0.617	69.4
4000	0.558	52.8	6.114	4.8	0.072	6.5	0.617	42.1

Typical Performance (Vd = 5V, Ic = 95mA, T = 25°C)

	•		-			
Freq	MHz	70	140	250	500	800
S21	dB	27.1	27.0	26.7	25.7	25
S11	dB	-32.0	-41.1	-38.5	-28.6	-23.2
S22	dB	-12.1	-11.6	-10.1	-7.2	-6.5
P1	dBm	21.3	21.5	21.5	21	19.7
OIP3	dBm	40.0	38.5	38.0	36.0	32.5
NF	dB	2.9	2.9	3.0	3.0	3.0

Typical Performance (Vd = 4.7V, Ic = 78mA, T = 25°C)

Freq	MHz	70	140	250	500	800
S21	dB	26.7	26.6	26.4	25.7	24.6
S11	dB	-28.5	-32.5	-29.2	-23.3	-19.8
S22	dB	-10.9	-11	-10.4	-8.2	-6
P1	dBm	20	20.5	20.5	20	19
OIP3	dBm	35.5	35.5	35	33	31.5
NF	dB	2.9	2.9	3.0	3.0	3.0

Typical Performance (Vd = 4.5V, Ic = 67mA, T = 25°C)

Freq	MHz	70	140	250	500	800
S21	dB	26.7	26.6	26.2	25.1	24.5
S11	dB	-26.6	-28.2	-26	-21.6	-18.8
S22	dB	-10.5	-10.6	-10.1	-8	-5.8
P1	dBm	18.8	19.2	19.5	19.6	17.4
OIP3	dBm	34.5	34.0	33.0	31.5	33
NF	dB	2.9	2.9	3.0	3.0	3.0

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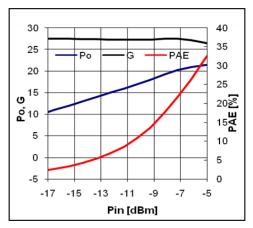
•website: <u>www.berex.com</u>

email: sales@berex.com

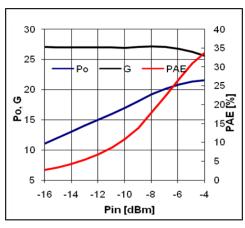


Device Performance

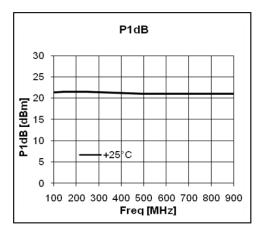
Pin-Pout-Gain

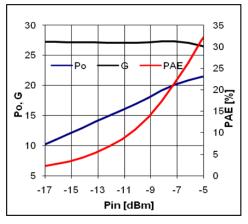


70MHz, 5V/95mA

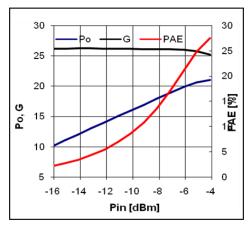


250MHz, 5V/95mA





140MHz, 5V/95mA

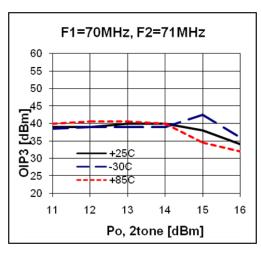


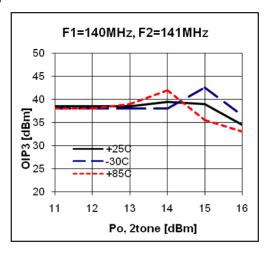
500MHz, 5V/95mA

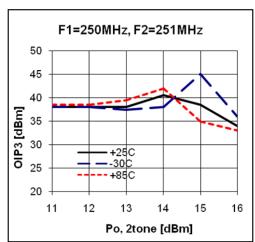
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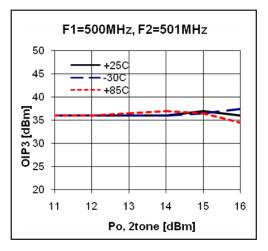


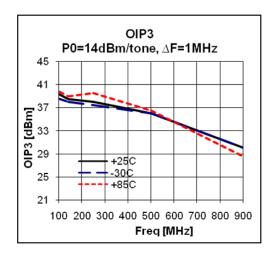
OIP3







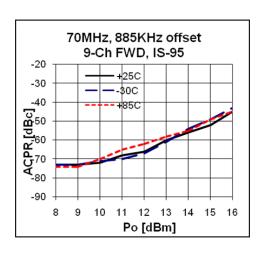


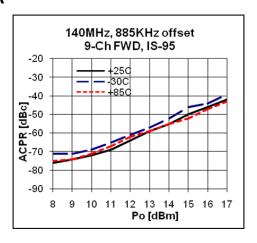


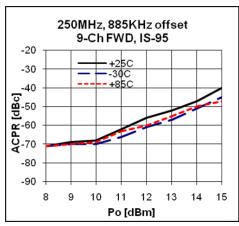
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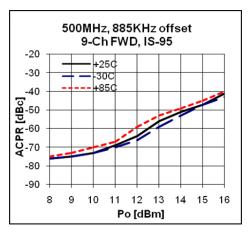


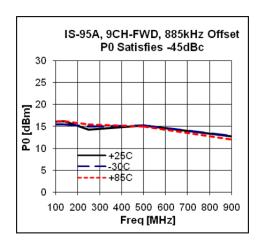
ACPR





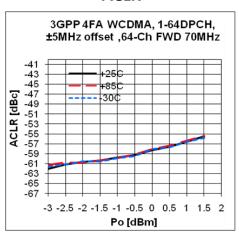




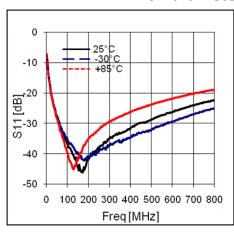


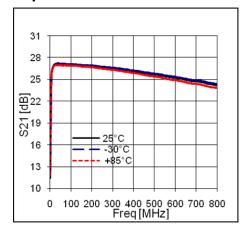


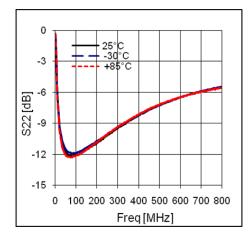
ACLR

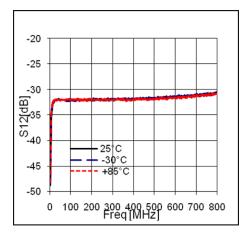


S-Parameters over Temperature







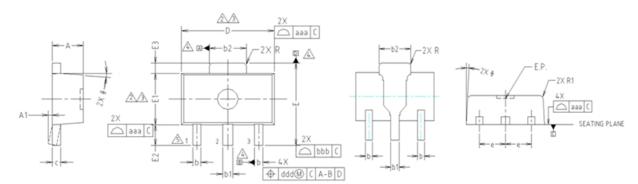


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•website: www.berex.com



Package Outline Dimension



NOTE:

1. DIMENSIONS IN MILLIMETERS.

DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 8.5mm PER END.

DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.

INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 8.5mm PER SIDE.

DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

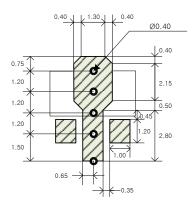
A DATUMS A, B AND D TO BE DETERMINED 8.18mm FROM THE LEAD TIP.

TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

		MILLI	METERS	S	NOTE
SYMBOL	MINIMUM	NON	JINAL	MAXIMUM	NOIE
A	1.40	1	.50	1.60	
A1	0.00		_	0.10	
ь	0.38	0).42	0.48	
ь1	0.48	0	.52	0.58	
b2	1.79	1	.82	1.87	
С	0.40	0	.42	0.46	
D	4.40	4	.50	4.70	2,3
Ε	3.70	4	.00	4.30	
E E1	2.40	2	.50	2.70	2,3
E2	0.80	1	.00	1.20	
E3	0.40	0	.50	0.60	
e		1.5	0 TYP.		
0			TYP.		
R		0.1	5 TYP.		
R1	-		_	0.20	
SYMBOL	TOLERANCES OF AND POSI	FORM	NOTE		
aaa	0.15				
bbb	0.20]	
ccc	0.10				
ddd	0.10			1	

Suggested PCB Land Pattern and PAD Layout

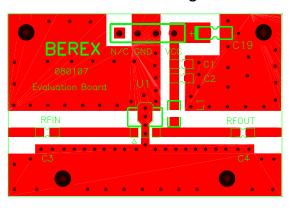
PCB Land Pattern



Note: All dimension _ millimeters

PCB lay out _ on BeRex website

PCB Mounting



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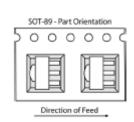


Package Marking



Tape & Reel

SOT89



Packaging information:

Tape Width (mm): 12
Reel Size (inches): 7
Device Cavity Pitch (mm): 8
Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 1C

Value: Passes <2000V

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114B

MSL Rating: Level 1 at +265°C convection reflow

Standard: JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

NATO CAGE code:

2	N	9	6	F

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